

P-Channel Enhancement-Mode Vertical DMOS FETs

Ordering Information

BV _{DSS} /	R _{DS(ON)}	l _{D(ON)} (min)	Order Numb	er / Package
BV _{DGS}	(max)		TO-39	TO-92
-60V	0.9Ω	-4A	VP2206N2	VP2206N3

[†]MIL visual screening available

High Reliability Devices

See pages 5-4 and 5-5 for MILITARY STANDARD Process Flows and Ordering Information.

Features

- □ Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- $\hfill\square$ Low $C_{_{ISS}}$ and fast switching speeds
- Excellent thermal stability
- □ Integral Source-Drain diode
- □ High input impedance and high gain
- □ Complementary N- and P-channel devices

Applications

- Motor controls
- Converters
- Amplifiers
- Switches
- Dever supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV _{DGS}
Gate-to-Source Voltage	± 20V
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

* Distance of 1.6 mm from case for 10 seconds.

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Advanced DMOS Technology

These enhancement-mode (normally-off) transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Package Options



Supertex Inc. does not recommend the use of its products in life support applications and will not knowingly sell its products for use in such applications unless it receives an adequate "products liability indemnification insurance agreement." Supertex does not assume responsibility for use of devices described and limits its liability to the replacement of devices determined to be defective due to workmanship. No responsibility is assumed for possible omissions or inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications, refer to the Supertex website: http://www.supertex.com. For complete liability information on all Supertex products, refer to the most current databook or to the Legal/Disclaimer page on the Supertex website.

Thermal Characteristics

Package	I _D (continuous)*	I _D (pulsed)	Power Dissipation θ_{jc} @ T _C = 25°C°C/W		θ _{ja} °C/W	I _{DR} *	I _{DRM}
TO-39	-0.75A	-8.0A	6.0W	20.8	125	-0.75A	-8.0A
TO-92	-0.64A	-4.0A	1.0W	125	170	-0.64A	-4.0A

* I_D (continuous) is limited by max rated T_i.

Electrical Characteristics (@ 25°C unless otherwise specified)

Symbol	Parameter	Min	Тур	Max	Unit	Conditions	
BV_{DSS}	Drain-to-Source Breakdown Voltage	-60			V	$V_{GS} = 0V, I_{D} = -10mA$	
V _{GS(th)}	Gate Threshold Voltage	-1.0		-3.5	V	$V_{GS} = V_{DS}, I_D = -10mA$	
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with Temperature		-4.3	-5.5	mV/°C	$V_{GS} = V_{DS}, I_D = -10mA$	
I _{GSS}	Gate Body Leakage		-1	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
I _{DSS}	Zero Gate Voltage Drain Current			-50	μΑ	$V_{GS} = 0V, V_{DS} = Max Rating$	
				-10	mA	$V_{GS} = 0V, V_{DS} = 0.8$ Max Rating $T_A = 125^{\circ}C$	
I _{D(ON)} C	ON-State Drain Current	-0.85	-2		Α	V _{GS} = -5V, V _{DS} = -25V	
		-4	-9			V _{GS} = -10V, V _{DS} =- 25V	
- US(ON)	Static Drain-to-Source ON-State Resistance		1.3	1.5	Ω	V _{GS} = -5V, I _D = -1A	
			0.75	0.9		V _{GS} = -10V, I _D = -3.5A	
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with Temperature		0.85	1.2	%/°C	V _{GS} = -10V, I _D = -3.5A	
G _{FS}	Forward Transconductance	0.8	1.4		2	$V_{DS} = -25V, I_{D} = -2A$	
C _{ISS}	Input Capacitance		325	450			
C _{OSS}	Common Source Output Capacitance		125	180	pF	V _{GS} = 0V, V _{DS} = -25V f = 1 MHz	
C _{RSS}	Reverse Transfer Capacitance		30	40			
t _{d(ON)}	Turn-ON Delay Time		4	15		$V_{DD} = -25V$	
t _r	Rise Time		16	25			
t _{d(OFF)}	Turn-OFF Delay Time		16	50	ns	$I_D = -4A$ $R_{GEN} = 10\Omega$	
t _f	Fall Time		22	50]		
V_{SD}	Diode Forward Voltage Drop		-1.1	-1.6	V	$V_{GS} = 0V, I_{SD} = -3.5A$	
t _{rr}	Reverse Recovery Time		500		ns	$V_{GS} = 0V, I_{SD} = -1A$	

Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300 µs pulse, 2% duty cycle.)

Note 2: All A.C. parameters sample tested.

Switching Waveforms and Test Circuit



Typical Performance Curves





Power Dissipation vs. Case Temperature



Thermal Response Characteristics



VP2206

Typical Performance Curves









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